

Open Access at IEEE

Workflow for Authors - 2023



Background

IEEE provides discounted fully OA APC Tokens for CONCERT member schools that subscribe to the IEL database:

- 1) When an affiliated corresponding author publishes a paper in an IEEE Fully OA journal, an institutional discount
 offer will automatically apply.
- During the submission process, the corresponding author shall enter the school email address and/or the institution data, as it will be used to match the author with an institutional OA account.
- 3) Authors can use a discounted APC Token USD1,560** to publish a manuscript.
- 4) This offer cannot be combined with any other promotion.
- 5) Token Request will be submitted to the institution administrator for review and approval .
- 6) If a different APC offer is preferred, you can contact the administrator at your institution or ieee_oa@hintoninfo.com to decline the special offer. After the administrator denies the default request, the corresponding author will receive an email from RSLC to pay the APC

* https://open.ieee.org/about/

IEEE Fully OA Journals include IEEE Topical Journals and IEEE Access

**2023 Standard APC for IEEE Fully OA Journals = USD1,950

Open Access allows authors to publish in respected, high-quality, scholarly journals, while also complying with the latest open access policies. IEEE makes the transition simple by providing several options for authors to choose from:

- Fully Open Access Topical Journals 🔶
- Hybrid Journals 🔶
- IEEE Access (Multidisciplinary Open Access Journal)

Author Process

Step 1 Submission process

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Step 2 Post acceptance



IEEE Electronic Copyright Form



Step 3 RightsLink for Scientific Communications (RLSC)



RightsLink



Submission – Step 1 – Fully OA journal

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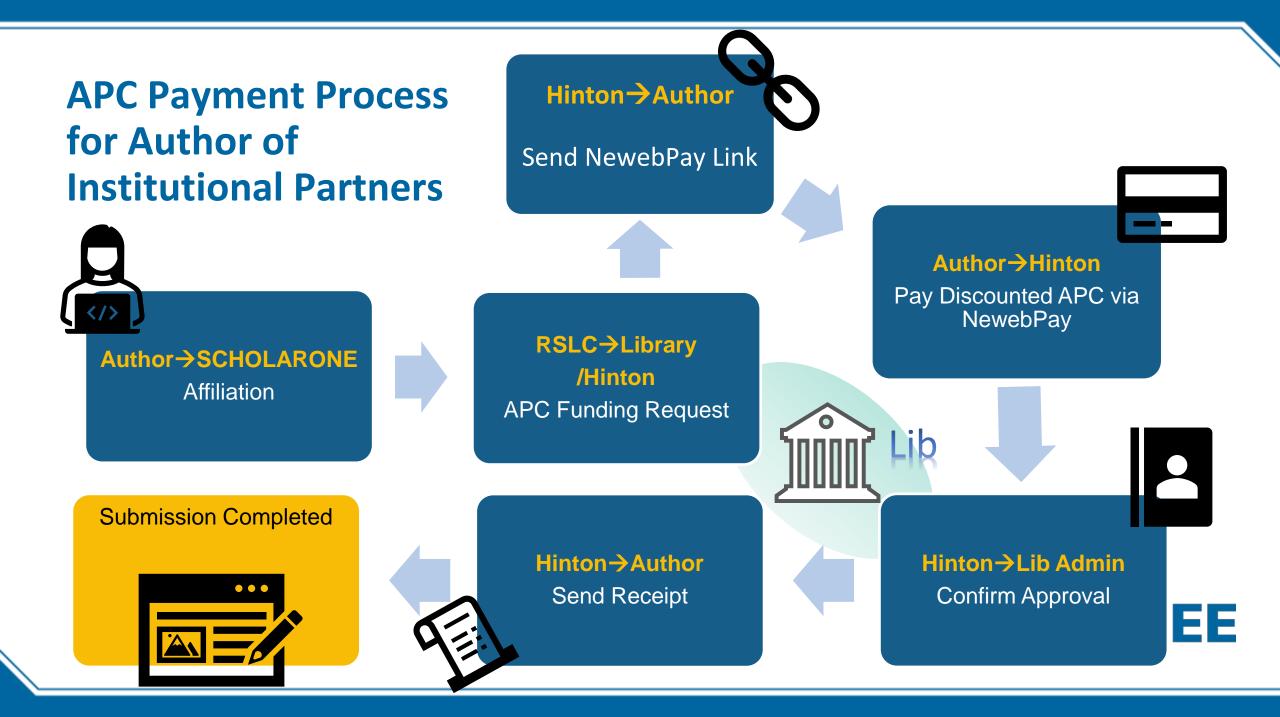
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Administrator Process

Responding to funding requests, reporting, and setting alerts



Account Administrator capabilities

- The Institution Portal in RightsLink for Scientific Communications (RLSC) allows administrators to:
 - View pending transactions.
 - Approve or deny funding requests.
 - Manage notifications.
 - Pull transaction reports.
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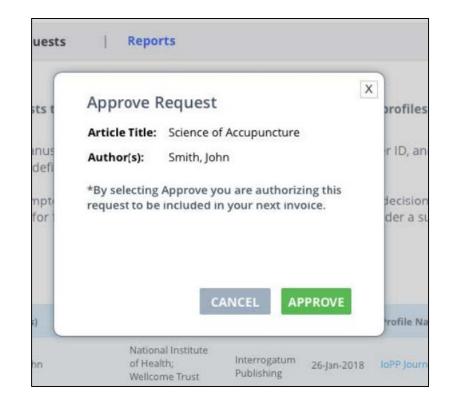
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